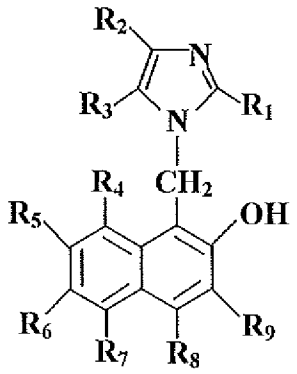
Amendments to the Claims

This listing of claims will replace all prior versions, and listings, of claims in the application:

Listing of Claims

This listing of claims will replace all prior versions, and listings, of claims in the application:

Claim 1 (previously presented). Composition comprising as component A) a 1-imidazolylmethyl-substituted 2-naphthol compound of the general formula (I)



(I)

where

R_1, R_2, and R_3 each independently of one another are H; C_{1-17} alkyl; C_{3-12} cycloalkyl, optionally substituted by C_{1-4} alkyl groups; C_{4-20} cycloalkyl-alkyl, optionally substituted by C_{1-4} alkyl groups; C_{6-10} aryl, optionally substituted by 1-3 C_{1-4} alkyl groups; C_{7-15} phenylalkyl, optionally substituted by 1-3 C_{1-4} alkyl groups; C_{3-17} alkenyl; C_{3-12} alkynyl; or aromatic or aliphatic C_{3-12} acyl;

R_4, R_5, R_6, R_7, R_8 and R_9 each independently of one another are H; C_{1-12} alkyl; C_{3-12} cycloalkyl, optionally substituted by C_{1-4} alkyl groups; C_{4-20} cycloalkyl-alkyl, optionally

substituted by C_{1-4} alkyl groups; C_{6-10} aryl, optionally substituted by 1-3 C_{1-4} alkyl groups; C_{7-15} phenylalkyl, optionally substituted by 1-3 C_{1-4} alkyl groups; C_{3-17} alkenyl; C_{3-12} alkynyl; C_{1-12} alkoxy; or OH; and

as component B) a phenol selected from the group consisting of 1,4-n-pentylphenol, n-hexylphenol, n-heptylphenol, n-octyphenol, n-decylphenol, and O,O'-diallyl-bisphenol A which is liquid at room temperature, with a weight ratio of component A) to component B) being from 25:75 to 50:50.

Claim 2 (currently amended). Composition according to claim ~~Claim~~ 1, wherein R_1, R_2 and R_3 each independently of one another are H; C_{1-12} alkyl; phenyl; or C_{7-15} phenylalkyl, optionally substituted by 1-3 C_{1-4} alkyl groups.

Claim 3 (currently amended). Composition according to claim ~~Claim~~ 2, wherein R_2 and R_3 are each H; and R_1 is C_{1-12} alkyl; phenyl; or C_{7-15} phenylalkyl, optionally substituted by 1-3 C_{1-4} alkyl groups.

Claim 4 (currently amended). Composition according to claim ~~Claim~~ 3, wherein R_{2-9} are a hydrogen atom and R_1 is C_{1-4} alkyl, or phenyl, optionally substituted by 1-3 C_{1-4} alkyl groups.

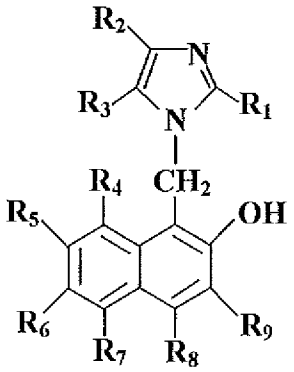
Claim 5 (previously presented). Composition according to claim ~~Claim~~ 1, wherein component B) is O,O'-diallyl-bisphenol A.

Claims 6-7 (cancelled).

Claim 8 (previously presented). Curable composition comprising:

a) an epoxy resin whose epoxide content is from 0.1 to 11 epoxide equivalents/kg;

b) from 5 to 40 parts by weight, based on the total weight of the curable composition, a composition comprising a 1-imidazolylmethyl-substituted 2-naphthol compound of the general formula (I)



(I)

where

R_1, R_2, and R_3 each independently of one another are H; C_{1-17} alkyl; C_{3-12} cycloalkyl, optionally substituted by C_{1-4} alkyl groups; C_{4-20} cycloalkyl-alkyl, optionally substituted by C_{1-4} alkyl groups; C_{6-10} aryl, optionally substituted by 1-3 C_{1-4} alkyl groups; C_{7-15} phenylalkyl, optionally substituted by 1-3 C_{1-4} alkyl groups; C_{3-17} alkenyl; C_{3-12} alkynyl; or aromatic or aliphatic C_{3-12} acyl;

R_4, R_5, R_6, R_7, R_8 and R_9 each independently of one another are H; C_{1-12} alkyl; C_{3-12} cycloalkyl, optionally substituted by C_{1-4} alkyl groups; C_{4-20} cycloalkyl-alkyl, optionally substituted by C_{1-4} alkyl groups; C_{6-10} aryl, optionally substituted by 1-

3 C_{1-4} alkyl groups; C_{7-15} phenylalkyl, optionally substituted by 1-3 C_{1-4} alkyl groups; C_{3-17} alkenyl; C_{3-12} alkynyl; C_{1-12} alkoxy; or OH; and

a phenol selected from the group consisting of 1,4-n-pentylphenol, n-hexylphenol, n-heptylphenol, n-octyphenol, n-decylphenol, and O,O'-diallyl-bisphenol A which is liquid at room temperature, the weight ratio of the 1-imidazolylmethyl-substituted 2-naphthol compound to phenol being from 25:75 to 50:50;

c) a curing agent for the epoxy resin having from 0.5 to 1.5 functional groups per epoxide group; and optionally

d) one or more additives.

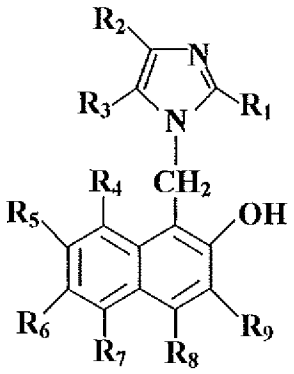
Claim 9 (currently amended). Composition according to claim ~~Claim~~ 8, wherein the curing agent is an amine or polyamine.

Claim 10 (currently amended). Composition according to claim ~~Claim~~ 9, characterized in that the curing agent is a polyoxypropylenediamine.

Claim 11 (original). Composition according to Claim 8, characterized in that the epoxy resin is a glycidyl ether, glycidyl ester, N-glycidyl or N,O-glycidyl derivative of an aromatic or heterocyclic compound, or a cycloaliphatic glycidyl compound.

Claim 12 (cancelled).

Claim 13 (previously presented). A method for making a curable composition comprising adding to an epoxy resin a curing agent, a 1-imidazolylmethyl-substituted 2-naphthol compound of the general formula (I)



(I)

where

R_1, R_2, and R_3 each independently of one another are H; C_{1-17} alkyl; C_{3-12} cycloalkyl, optionally substituted by C_{1-4} alkyl groups; C_{4-20} cycloalkyl-alkyl, optionally substituted by C_{1-4} alkyl groups; C_{6-10} aryl, optionally substituted by 1-3 C_{1-4} alkyl groups; C_{7-15} phenylalkyl, optionally substituted by 1-3 C_{1-4} alkyl groups; C_{3-17} alkenyl; C_{3-12} alkynyl; or aromatic or aliphatic C_{3-12} acyl;

R_4, R_5, R_6, R_7, R_8 and R_9 each independently of one another are H; C_{1-12} alkyl; C_{3-12} cycloalkyl, optionally substituted by C_{1-4} alkyl groups; C_{4-20} cycloalkyl-alkyl, optionally substituted by C_{1-4} alkyl groups; C_{6-10} aryl, optionally substituted by 1-3 C_{1-4} alkyl groups; C_{7-15} phenylalkyl, optionally substituted by 1-3 C_{1-4} alkyl groups; C_{3-17} alkenyl; C_{3-12} alkynyl; C_{1-12} alkoxy; or OH; and

a phenol selected from the group consisting of 1,4-n-pentylphenol, n-hexylphenol, n-heptylphenol, n-octyphenol, n-decylphenol, and O,O'-diallyl-bisphenol A which is liquid at room temperature, the weight ratio of the 1-imidazolylmethyl-substituted 2-naphthol compound to phenol being from 25:75 to 50:50.

Claim 14 (previously presented). The method of claim 13 wherein the 1-imidazolylmethyl-substituted 2-naphthol compound of formula (I) and the phenol are dissolved beforehand in the curing agent at a temperature between 60° - 80° C.

Claim 15 (currently amended). A prepreg comprising a curable composition according to claim ~~Claim~~ 8.